

PCB P/N

MCPCB. **96-48** 8-4 24. **()**

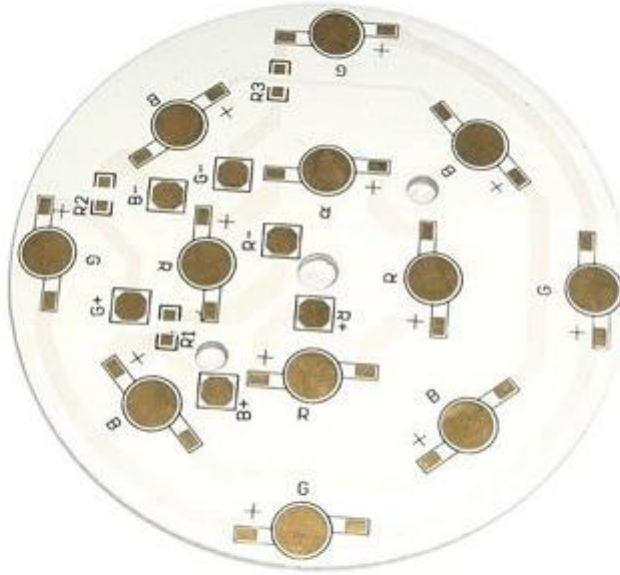
025. 020

25

():

PCB P/N

PCB P / N	LC057-V1
PCB P / N	1L
PCB P / N	PCB P / N
PCB P / N thk	1.6MM
PCB P / N	11OZ
PCB P / N	/
PCB P / N () ()	/
PCB P / N	15mil
PCB P / N. Y / N ()	
PCB P / N	ENIG (Au: 0.05um)
PCB P / N	PCB P / N
PCB P / N	Dim X (mm): 89 Dim Y (mm): 175
Panelisation	Dim X (mm): 89 Dim Y (mm): 175 No of UPS: 1
PCB P / N	
PCB P / N	CNC



www.o-leading.com

XXXXXXXXXXXXXXXXXXXXXXXXXXXX

XXXXXXXXXXXX

1. XXXX XXX O-Leading XXXXXXXX
 XXX XX XX XXXXXXXX XXXXXXXX XXXXXXX XXXXXXX XXXXXXX.
 1. XXXXXXXX XXXXXXX XXXXXXXX XXX XX XXXXX XXXXXXXX XXX ISO 9001: 2008.
 2. XXXXXXXX XXXXXXX XXXXXXX XX XXXXXXXX XXXXXXXX XXXXXXXX
 3. XXXXXXXX XXXXXXX XXX XX XXXXXXXX XXXXXXX XXXXX .XXXXXXXXXXXX XXXXXXXX XXXXXXX XX XXXXXXXX XX AOI (XXXXXXXX
 XXXXXXXX XXXXXXX) XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXX (XXXXXXXX XXXXXXXX).
 4. XXXXXXX XXXXX XXXXXXX XXXXXXX XX XXXXXXX XXXXX XXXXX XXXXXXX
 5. XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXX
2. XXXXX XXX O-Leading XXXXXXXXXXXXXXX XXXXXXX XXX
 XX (XXXXXXXXXXXXX XXXXXXXX XXXXXXX XXX) XXXXXXX XXXXXXX XX XXXXXXX XXXXXXX XXXXXXX XX XXXXXXX XXXXXXX XXXXX
 .XXXXXXXXXXXX XXXXXXXX XXX XX 31 XXXXX XXXXXXXX XXXXXXX XXXXX XXXXXXXX .XXXXXXXX XXXXXXX XX XXXXX XXXXX XXXXXXXX
 XXXXXXX XX XXX XXX .XXXXX XXXXX XXXXX XXXXXXX XXXXXXX XXXXXXX XXXXXXX O-Leading XXX .XXXXXXXX XXXXXXXX XXX
 XXXXXXX XXXXXXXX XXXXXXXX .XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXX XXXXXXX XXX XX XXXXXXXX XXXXXXX XXXXXXX
 XXXXXXX XXXXXXX XXXXX XXXXXXXX XX.
 XXXXX XX XXXXX XX XXXXXXXX XXX XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXX .XXXXXXXX XX XXXXXXX XXXXXXX XXXXX XXX
 XXXXXXXX XXXXXXXX.

3. what is the difference between o- and o+ PCBs?

FR4 PCB is a common PCB material. TG (Glass Transition Temperature) is the temperature at which the material changes from a hard solid to a soft, viscous state. Rogers, Arlon, Teflon are high-frequency PCB materials. PI (Polyimide) is a high-temperature resistant PCB material.

4. What are the common PCB design software tools?

Common PCB design software tools include Gerber 274-X, Cam350, CAD, Protel 99se, PADS, DXP, Eagle.

5. What are the common PCB manufacturing processes?

Common PCB manufacturing processes include AOI (Automated Optical Inspection), PTH (Plated Through Hole), AOI (Automated Optical Inspection), AOI (Automated Optical Inspection), AOI (Automated Optical Inspection), E/T (Electroplating/Through Hole).

فریقنا



Factory PCB



Automatic vacuum press machine



Drilling Machine



Pattern Plating Machine



Scrubbing Machine



Developing Machine



Routing Machine



High-speed flying probe machine



E-test Machine

Factory SMT



الشهادات

CICC INSPECTION CERTIFICATION



嘉泰认证

QUALITY MANAGEMENT SYSTEM CERTIFICATE

Certificate No: 18118Q10347R05

We hereby certify that

O-LEADING SUPPLY CHAIN(HK) CO.,LIMITED

Credit No: 61691591-000-07-18-7

Registration Add: FLAT/RM 1205 12/F TAI SANG BANK BUILDING 130-132 DES VOEUS ROAD CENTRAL HK

Business Add: 1213, Floor 13, Fortune Building, Danshui Town, Huiyang District, Huizhou, Guangdong, China

Has implemented and maintains a **Quality Management System** Which fulfills the requirements of the following standards
GB/T19001-2016 idt ISO9001:2015

Scope of certification
Sales of printed circuit boards

Initial issuance period: February 27, 2018
Renewal date: April 22, 2019
This certificate is valid during: April 22, 2019 – February 26, 2021
This certificate is invalid without CICC qualified label in the following period

First supervision and audit	Second supervision and audit	Qualified mark
-----------------------------	------------------------------	----------------

The certificate registration fee does not include those production stages which fail to be covered by the relevant effective administrative procedures and qualification procedures stipulated by the state. The effectiveness of this certificate shall be restricted to those activities which are covered by the certificate. The actual information of this certificate can be searched on the internet of CICC www.cicc.com.cn. For the sake of clarity see also the note.






CICC INSPECTION CERTIFICATION



嘉泰认证

质量管理体系认证证书

证书号: 18118Q10347R05

兹证明

诚领供应链(香港)有限公司

统一社会信用代码: 61691591-000-07-18-7

注册地址: 香港中環德輔道中130-132號大生銀行大廈1205室

经营地址: 广东惠州惠阳淡水南亨西路财富大厦13楼1313

建立的质量管理体系符合

GB/T19001-2016 idt ISO9001:2015 质量标准适用条款的要求

认证范围
印刷线路板的销售

初次获证日期: 2018年02月27日
换证日期: 2019年04月22日
证书有效期: 自2019年04月22日至2021年02月26日
在下列期限内, 未经CICC黏贴合格标贴, 本证书无效

第一次监督	第二次监督	黏贴处
-------	-------	-----

本证书认证范围不包括未取得有效的国家规定的行政许可、资质许可的产品/服务范围; 本证书通过CICC定期监督审核保持, 与年度《保持认证通知书》共同方为有效; 本证书信息可在国家认监委网站: www.cnca.gov.cn及CICC网站www.cicc.com.cn查询。








Test Report

No. SZXEC1900530401 Date: 30 Mar 2019 Page 1 of 6

O-LEADING SUPPLY CHAIN (HK) CO., LIMITED

1313.FLOOR 13, FORTUNE BUILDING, DANSHUI TOWN, HUIYANG DISTRICT, HUIZHOU, GUANGDONG, CHINA

The following sample(s) was/were submitted and identified on behalf of the clients as : OSP

SGS Job No. : RP19-005089 - SZ
Date of Sample Received : 22 Mar 2019
Testing Period : 22 Mar 2019 - 30 Mar 2019
Test Requested : Selected test(s) as requested by client.
Test Method : Please refer to next page(s).
Test Results : Please refer to next page(s).

Conclusion : Based on the performed tests on submitted sample(s), the results of Lead, Mercury, Cadmium, Hexavalent chromium, Polybrominated biphenyls (PBBs), Polybrominated diphenyl ethers (PBDEs) and Phthalates such as Bis(2-ethylhexyl) phthalate (DEHP), Butyl benzyl phthalate (BBP), Dibutyl phthalate (DBP), and Diisobutyl phthalate (DIBP) comply with the limits as set by RoHS Directive (EU) 2015/863 amending Annex II to Directive 2011/65/EU.

Signed for and on behalf of
SGS-CSTC Standards Technical Services Co., Ltd. Shenzhen Branch

Tina
Tina Fan
Approved Signatory



Unless otherwise agreed in writing, this document is issued by the Company subject to its General Conditions of Service printed overleaf, available on request or accessible at http://www.sgs.com/terms-and-conditions.aspx and, for electronic format documents, subject to Terms and Conditions for Electronic Documents at http://www.sgs.com/terms-and-conditions/Electronic-Document.aspx. Attention is drawn to the limitation of liability, indemnification and jurisdiction issues defined therein. Any holder of this document is advised that unless he/she expressly agrees to the Company's liability at the time of its intended use, the limits of the Company's liability are restricted to the extent of the Company's liability under the transaction documents. This document cannot be reproduced or transmitted in any form or by any means, electronic or mechanical, including photocopying, recording, or by any information storage and retrieval system, without prior written approval of the Company. Any unauthorized alteration, forgery or falsification of the content or appearance of this document is unlawful and offenders may be prosecuted to the fullest extent of the law. Unless otherwise stated the results shown in this report refer only to the samples tested.

Member of the SGS Group (SGS SA)



Test Report

No. SZXEC1900530401 Date: 30 Mar 2019 Page 2 of 6

Test Results :

Test Part Description :

Table with 3 columns: Specimen No., SGS Sample ID, Description. Row 1: SN1, SZX19-005304.001, Green"PCB"

Remarks :

- (1) 1 mg/kg = 1 ppm = 0.0001%
(2) MDL = Method Detection Limit
(3) ND = Not Detected (< MDL)
(4) "-" = Not Regulated

RoHS Directive (EU) 2015/863 amending Annex II to Directive 2011/65/EU

Test Method : With reference to IEC 62321-4:2013+A1:2017, IEC 62321-5:2013, IEC 62321-7-2:2017, IEC 62321-6:2015 and IEC 62321-8:2017, analyzed by ICP-OES, UV-Vis and GC-MS.

Table with 5 columns: Test Item(s), Limit, Unit, MDL, 0/1. Lists various substances like Cadmium, Lead, Mercury, Hexavalent Chromium, Sum of PBBs, etc. with their respective limits and detection results.



Unless otherwise agreed in writing, this document is issued by the Company subject to its General Conditions of Service printed overleaf, available on request or accessible at http://www.sgs.com/terms-and-conditions.aspx and, for electronic format documents, subject to Terms and Conditions for Electronic Documents at http://www.sgs.com/terms-and-conditions/Electronic-Document.aspx. Attention is drawn to the limitation of liability, indemnification and jurisdiction issues defined therein. Any holder of this document is advised that unless he/she expressly agrees to the Company's liability at the time of its intended use, the limits of the Company's liability are restricted to the extent of the Company's liability under the transaction documents. This document cannot be reproduced or transmitted in any form or by any means, electronic or mechanical, including photocopying, recording, or by any information storage and retrieval system, without prior written approval of the Company. Any unauthorized alteration, forgery or falsification of the content or appearance of this document is unlawful and offenders may be prosecuted to the fullest extent of the law. Unless otherwise stated the results shown in this report refer only to the samples tested.

Member of the SGS Group (SGS SA)



ZPMV2.E490354 - WIRING, PRINTED - COMPONENT

Wiring, Printed - Component

See General Information for Wiring, Printed - Component

O-LEADING SUPPLY CHAIN (HK) CO LTD
 ROOM 1205, 12/F
 TAI SANG BANK BLDG
 130-132 DES VOEUS ROAD
 CENTRAL, HONG KONG

E490354

Type	Cond Width		Cond Thk	SS/ DS/ DSO	Max	Max		Meets	C			
	Min	Edge			Area	Solder Limits	Oper Temp			Flame		
	mm(in)	mm(in)	mic(mil)		mm(in)	C	sec	C	Class	UL796	DSR	I
Multilayer (mass laminate) printed wiring boards.												
O-LEADING-401	0.1 (0.004)	0.3 (0.012)	34 (1.34)	DS	12.7 (0.5)	260	10	130	V-0	-	-	
O-LEADING-407	0.08 (0.003)	0.2 (0.008)	17 (0.67)	DS	9.7 (0.4)	260	10	130	V-0	All	-	
Multilayer printed wiring boards.												
O-LEADING-408	0.125 (0.005)	0.125 (0.005)	12 (0.47) Int:136	DS	50.8 (2.0)	280	20	130	V-0	All	*	
Single layer printed wiring boards.												
O-LEADING-002	0.38 (0.015)	1.14 (0.045)	34 (1.34)	SS	19.1 (0.8)	260	10	105	V-0	All	-	
O-LEADING-003	0.38 (0.015)	1.14 (0.045)	34 (1.34)	SS	19.1 (0.8)	260	10	130	V-0	▲	-	
O-LEADING-033	0.15 (0.006)	0.3 (0.012)	34 (1.34)	SS	25.4 (1.0)	260	10	120	V-0	All	-	
O-LEADING-205	0.1 (0.004)	0.3 (0.012)	34 (1.34)	DS	69.6 (2.7)	260	10	130	V-0	All	-	
O-LEADING-206	0.15 (0.006)	0.33 (0.013)	17 (0.67)	DS	69.6 (2.7)	260	10	130	V-0	All	-	
O-LEADING-D01	0.14 (0.006)	0.15 (0.006)	33 (1.30)	DS	25.4 (1.0)	260	10	130	V-0	All	*	
O-LEADING-S01	0.25 (0.010)	0.25 (0.010)	17 (0.67)	SS	25.4 (1.0)	260	4	130	V-0	All	*	

WIRING, PRINTED - COMPONENT | UL Product iQ

O-LEADING-S02	0.2 (0.008)	0.2 (0.008)	17 (0.67)	SS	25.4 (1.0)	260	4	130	HB	▲	*	
O-LEADING-S03	0.25 (0.010)	0.25 (0.010)	34 (1.34)	SS	25.4 (1.0)	260	4	130	V-0	All	*	

* - CTI marking is optional and may be marked on the printed wiring board.

Marking: Company name or file number and type designation. May be followed by a suffix to denote factory identification or burning test classification.

并不是所有出现在本数据库中的公司名称和产品都满足了UL跟踪检验服务的要求。只有带有UL标志的产品，才应该被视为经过UL认证，并满足UL跟踪检验服务的要求。注意查看产品上的标志。

UL 允许在线认证目录中所含材料的复制遵循以下条件：1.指南信息、装配、构造、设计、系统和/或认证（文件）必须在不篡改任何数据（或图纸）的情况下完整且无误导性地呈现。2.经 UL 允许从在线认证目录转载“声明必须出现在所提取材料的邻近位置。此外，转载材料必须包含以下格式的版权声明：“© 2019 UL LLC”

التغليف والشحن

Shipping service



DHL
WORLDWIDE EXPRESS®

TNT

FedEx
Express®



Quick Turn Lead Time		
Layer Count:	Lead Tim	Special Requirement
1L/2L	2-3days	24 Hours,48 Hours
4L	3-4days	48 Hours
6L	4-5days	72 Hours
8L	5-6days	NA
10L	6-7days	NA
12L	7-8days	NA
14L	8-9days	NA

Standard Lead Time		
Layer Count:	Sample Lead Time	Volume order lead time
2L	4 days	10 days
4L	5 days	11 days
6L	6 days	12 days
8L	8 days	14 days
10L	10 days	16 days
12L	12 days	18 days
14L	14 days	20 days
16-32L	18 days	24 days

القدرة العملية

قدرات إنتاج ثنائي الفينيل متعدد الكلور

1 Layer-32Layer عدد الطبقات:

oz-12oz الانتهاء من سماكة النحاس □ 1 / 3

3.0mil / 3.0mil دقيقة خط العرض / تباعد الداخلية □ 3.0

4.0mil / 4.0mil دقيقة خط العرض / تباعد خارجي: 4.0

نسبة العرض إلى الارتفاع القصوى: 10: 1

سمك المجلس □ 0.2 مم-5.0 مم

الحد الأقصى لحجم اللوحة (بوصة): 635 * 1500 مم

4mil الحد الأدنى لحفر حفرة الحجم:

3mil مثقوب حفرة التسامح: +/- 3

دفن فيا (أنواع أخي): نعم / Blind

عبر التعبئة (موصل ، غير موصل): نعم

قاعدة ألومنيوم،النسبة الثابتة ،Rogers, Halogen free material, FR-4, FR-4high Tg.المواد الأساسية

النحاس الثقيل

تين ، أصابع الذهب ، حبر الكربون Immersion,Immersion الفضة ، HAL-LF ، ENIG ، OSP ، HASL :التشطيبات السطحية

قدرات الإنتاج SMT

لوحة الألومنيوم ، CEM-3 ، CEM-1 ، FR-4 :مادة الكلور
460mmxأقصى حجم ثنائي الفينيل متعدد الكلور: 510
50mmx50ممين حجم الكلور □
mm-4.5سمك □ PCB 0.5
mm □ المجلس 4-0.5
الحد الأدنى لحجم المكونات: 0201
مكون حجم رقاقة القياسية: 0603 وأكبر
مكون أقصى ارتفاع □ 15 ملم
دقيقة الملعب الرصاص: 0.3 مم
دقيقة الملعب الكرة بغا: 0.4 ملليمتر
mmدقة التنسيب: +/- 0.03